



A Product Line of Diodes Incorporated



ZXTN620MA

#### **80V NPN LOW SATURATION TRANSISTOR**

## **Features and Benefits**

- BV<sub>CEO</sub> > 80V
- I<sub>C</sub> = 3.5A Continuous Collector Current
- Low Saturation Voltage (185mV max @ 1A)
- $R_{SAT} = 68 \text{ m}\Omega$  for a low equivalent On-Resistance
- h<sub>FE</sub> specified up to 5A for high current gain hold up
- Low profile 0.6mm high package for thin applications
- R<sub>0JA</sub> efficient, 60% lower than SOT23
- 4mm<sup>2</sup> footprint, 50% smaller than SOT23
- Lead-Free, RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: DFN2020B-3
- Case Material: Molded Plastic. "Green" Molding Compound.
- Terminals: Pre-Plated NiPdAu leadframe.
- Nominal Package Height: 0.6mm
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.01 grams (approximate)

## **Applications**

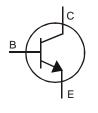
- MOSFET Gate Driving
- DC–DC Converters
- Charging circuits
- Motor Control
- Power switches

DFN2020B-3

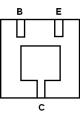


Top View

Bottom View



**Device Symbol** 



Bottom View Pin-Out

## Ordering Information

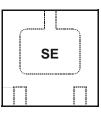
Notes:

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTN620MATA	SE	7	8	3000

1. No purposefully added lead.

2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com

# **Marking Information**



SE = Product Type Marking code

Top View





## ZXTN620MA

### Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Parameter		Symbol	Limit	Unit	
Collector-Base Voltage		V <sub>CBO</sub>	100	V	
Collector-Emitter Voltage		V <sub>CEO</sub>	80		
Emitter-Base Voltage		V <sub>EBO</sub>	7		
Peak Pulse Current		I <sub>CM</sub>	5		
Continuous Collector Current	(Note 3)	1-	3.5	^	
Continuous Collector Current	(Note 4)	Ic	3.8	A	
Base Current		I <sub>B</sub>	1		

# Thermal Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit		
Power Dissipation	(Note 3)		1.5 12	W mW/°C	
Linear Derating Factor	(Note 4)	– P <sub>D</sub> –	2.45 19.6		
Thermal Resistance, Junction to Ambient	(Note 3)	R <sub>0JA</sub>	83		
	(Note 4)	IXθJA	51	°C/W	
Thermal Resistance, Junction to Lead	(Note 5)	R <sub>0JL</sub>	16.8		
Operating and Storage Temperature Range		T <sub>J.</sub> T <sub>STG</sub>	-55 to +150	°C	

3. For a device surface mounted on 31mm x 31mm (10cm<sup>2</sup>) FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is Notes: measured when operating in a steady-state condition. The entire exposed collector pad is attached to the heatsink.

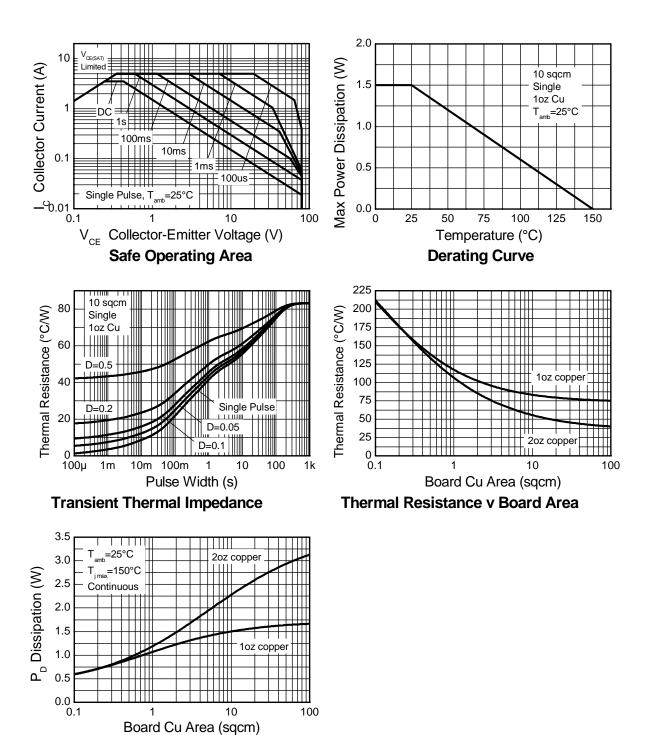
4. Same as note (3), except the device is measured at  $t \le 5$  sec.

5. For a single device, thermal resistance from junction to solder-point (at the end of the drain lead).





### **Thermal Characteristics**



Power Dissipation v Board Area





# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

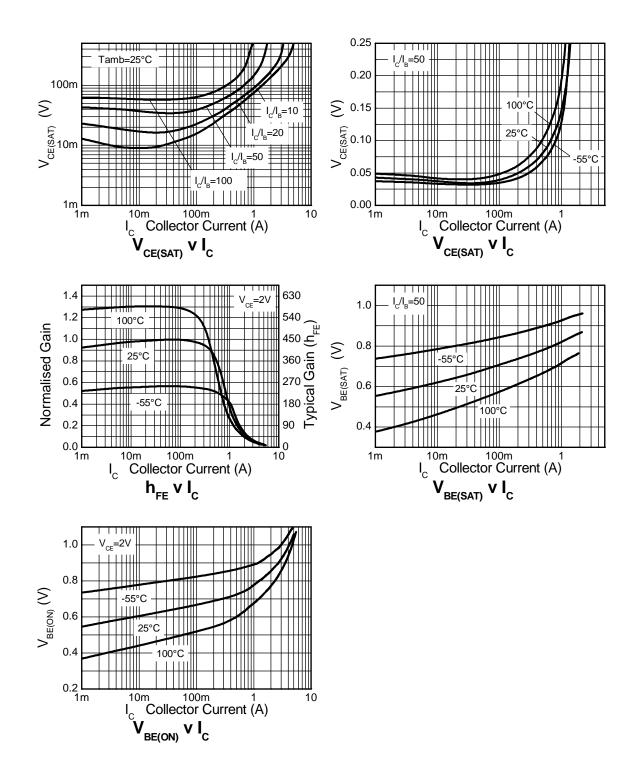
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	100	180	-	V	I <sub>C</sub> = 100 μA
Collector-Emitter Breakdown Voltage (Note 6)	BV <sub>CEO</sub>	80	110	-	V	I <sub>C</sub> = 10 mA
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	8.2	-	V	I <sub>E</sub> = 100 μA
Collector Cutoff Current	ICBO	-	-	100	nA	$V_{CB} = 80V$
Emitter Cutoff Current	I <sub>EBO</sub>	-	-	100	. nA	$V_{EB} = 6V$
Collector Emitter Cutoff Current	ICES	-	-	100	nA	V <sub>CE</sub> = 65V
Static Forward Current Transfer Ratio (Note 6)	h <sub>FE</sub>	200 300 110 60 20 -	450 450 170 90 30 10	- 900 - - -	-	$\begin{split} I_{C} &= 10 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 200 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 1 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 1.5 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 3 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} &= 5 \text{A}, \ V_{CE} = 2 \text{V} \end{split}$
Collector-Emitter Saturation Voltage (Note 6)	V <sub>CE(sat)</sub>		15 45 145 160 240	20 60 185 200 340	mV	$\begin{split} I_C &= 0.1A, \ I_B = 10mA \\ I_C &= 0.5A, \ I_B = 50mA \\ I_C &= 1A, \ I_B = 20mA \\ I_C &= 1.5A, \ I_B = 50mA \\ I_C &= 3.5A, \ I_B = 300mA \end{split}$
Base-Emitter Turn-On Voltage (Note 6)	V <sub>BE(on)</sub>	-	0.96	1.05	V	I <sub>C</sub> = 3.5A, V <sub>CE</sub> = 2V
Base-Emitter Saturation Voltage (Note 6)	V <sub>BE(sat)</sub>	-	1.09	1.175	V	I <sub>C</sub> = 3.5A, I <sub>B</sub> = 300mA
Output Capacitance	C <sub>obo</sub>	-	11.5	18	pF	V <sub>CB</sub> = 10V. f = 1MHz
Transition Frequency	f <sub>T</sub>	100	160	-	MHz	$V_{CE} = 10V, I_C = 50mA, f = 100MHz$
Turn-On Time	t <sub>on</sub>	-	86	-	ns	$V_{CC} = 10V, I_{C} = 1A$
Turn-Off Time	t <sub>off</sub>	-	1128	-	ns	$I_{B1} = I_{B2} = 25 \text{mA}$

Notes: 6. Measured under pulsed conditions. Pulse width  $\leq$  300 µs. Duty cycle  $\leq$  2%.





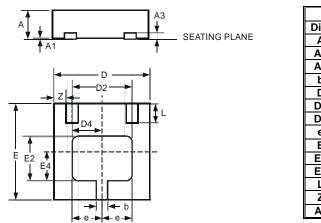
# **Typical Electrical Characteristics**





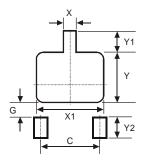


# **Package Outline Dimensions**



DFN2020B-3					
Dim	Min	Max	Тур		
Α	0.57	0.63	0.60		
A1	0	0.05	0.02		
A3			0.152		
b	0.20	0.30	0.25		
D	1.95	2.075	2.00		
D2	1.22	1.42	1.32		
D4	0.56	0.76	0.66		
е			0.65		
Е	1.95	2.075	2.00		
E2	0.79	0.99	0.89		
E4	0.48	0.68	0.58		
L	0.25	0.35	0.30		
Ζ			0.225		
All Dimensions in mm					

# **Suggested Pad Layout**



Dimensions	Value (in mm)			
С	1.30			
G	0.24			
Х	0.35			
X1	1.52			
Y	1.09			
Y1	0.47			
Y2	0.50			





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